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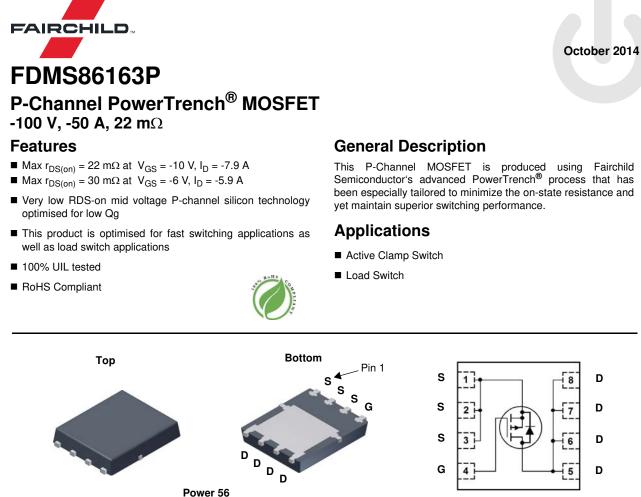
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MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units		
V _{DS}	Drain to Source Voltage			-100	V		
V _{GS}	Gate to Source Voltage			±25	V		
	Drain Current -Continuous	T _C = 25 °C		-50			
I _D	-Continuous	T _A = 25 °C	(Note 1a)	-7.9	Α		
	-Pulsed		(Note 4)	-100			
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	486	mJ		
P _D	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			104	w		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	VV		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C		

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a) 50	C/VV	

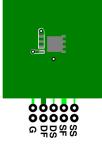
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86163P	FDMS86163P	Power 56	13 "	12 mm	3000 units

FDMS86163P P-Channel PowerTrench[®] MOSFET

1

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250 μA, V _{GS} = 0 V	-100			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		-59		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics	· · · · · · · · · · · · · · · · · · ·		1		
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \ \mu A$	-2	-2.8	-4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.1}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		6.2		mV/°C
		V _{GS} = -10 V, I _D = -7.9 A		17.8	22	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = -6 \text{ V}, \text{ I}_{D} = -5.9 \text{ A}$		21.3	30	mΩ
20(01)		V _{GS} = -10 V, I _D = -7.9 A,T _J = 125 °C		29	36	
9 _{FS}	Forward Transconductance	V _{DS} = -10 V, I _D = -7.9 A		29		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = -50 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz		3070	4085	pF
C _{oss}	Output Capacitance			501	670	pF
C _{rss}	Reverse Transfer Capacitance			21	35	pF
Rg	Gate Resistance		0.1	2.6	5.3	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			17	30	ns
t _r	Rise Time	V_{DD} = -50 V, I _D = -7.9 A, V _{GS} = -10 V, R _{GEN} = 6 Ω		8.8	18	ns
t _{d(off)}	Turn-Off Delay Time			33	53	ns
t _f	Fall Time			6.9	14	ns
Qg	Total Gate Charge	V _{GS} = 0 V to -10 V		42	59	nC
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } -6 V$ $V_{DD} = -50 V,$ $I_D = -7.9 A$		26	37	nC
Q _{gs}	Gate to Source Charge	I _D = -7.9 A		11.8		nC
Q _{gd}	Gate to Drain "Miller" Charge			7.1		nC
Drain-Sou	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -7.9 A$ (Note 2)		-0.81	-1.3	v
	-	$V_{GS} = 0 V, I_S = -2 A$ (Note 2)		-0.75	-1.2	1.2
t _{rr}	Reverse Recovery Time	I _F = -7.9 A, di/dt = 100 A/μs		63	102	ns
Q _{rr}	Reverse Recovery Charge			132	210	nC

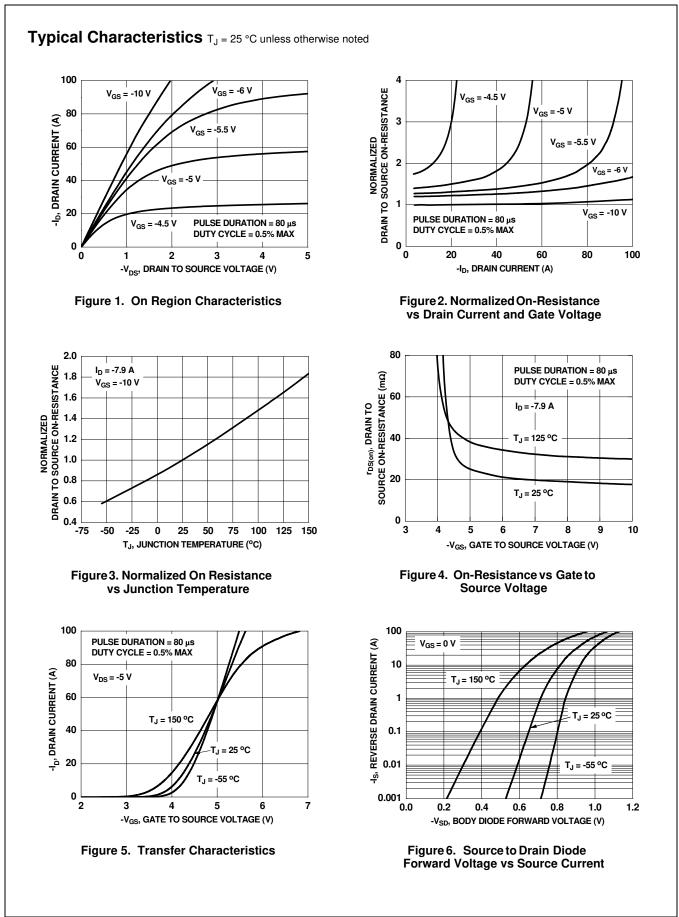


a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper

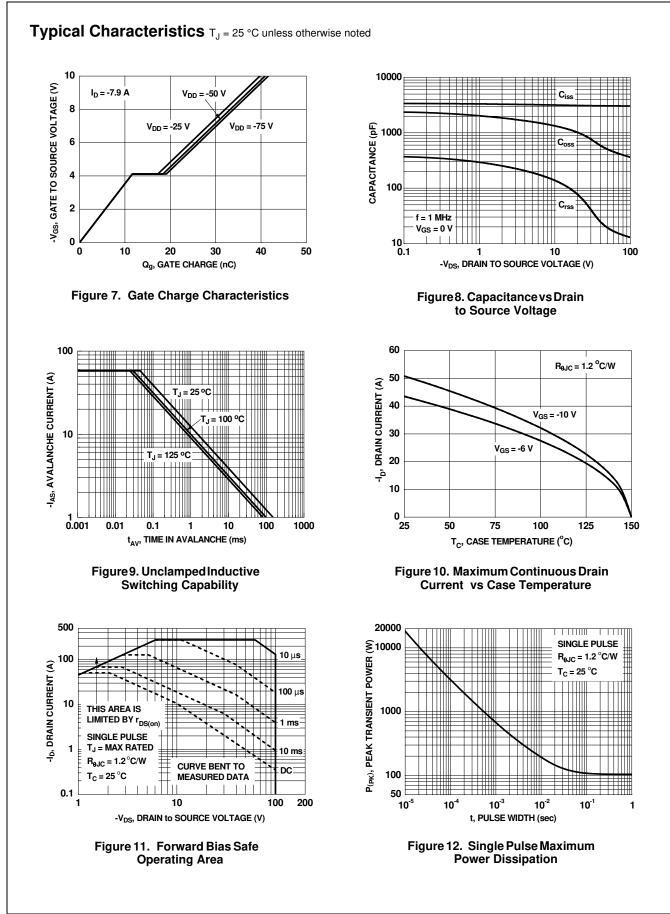


b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

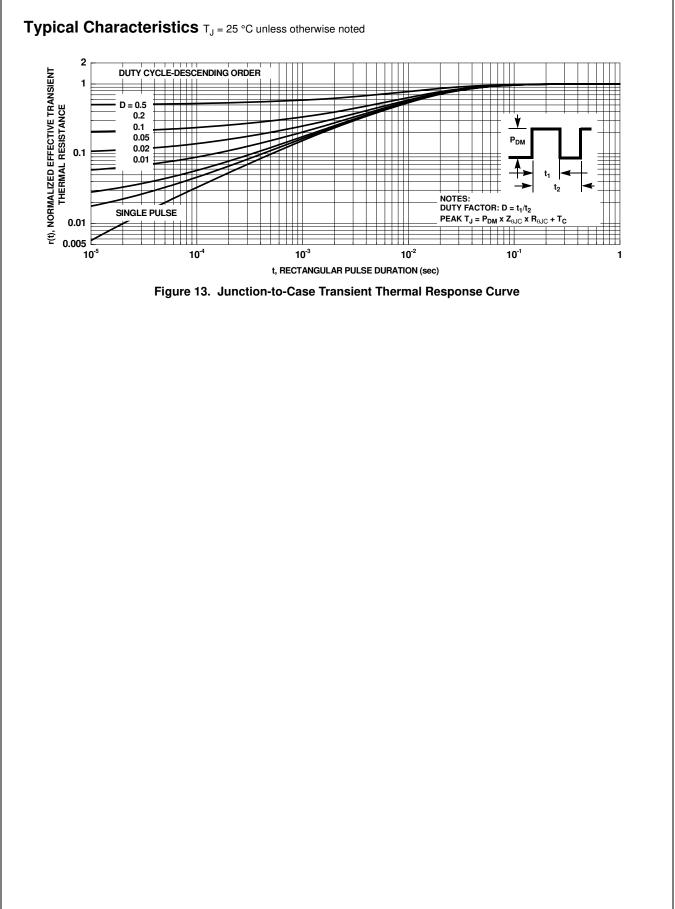
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T_J = 25 °C; P-ch: L = 3 mH, I_{AS} = -18 A, V_{DD} = -100 V, V_{GS} = -10 V. 100% test at L = 0.1 mH, I_{AS} = -58 A. 4. Pulse Id refers to Figure.11 Forward Bias Safe Operation Area.

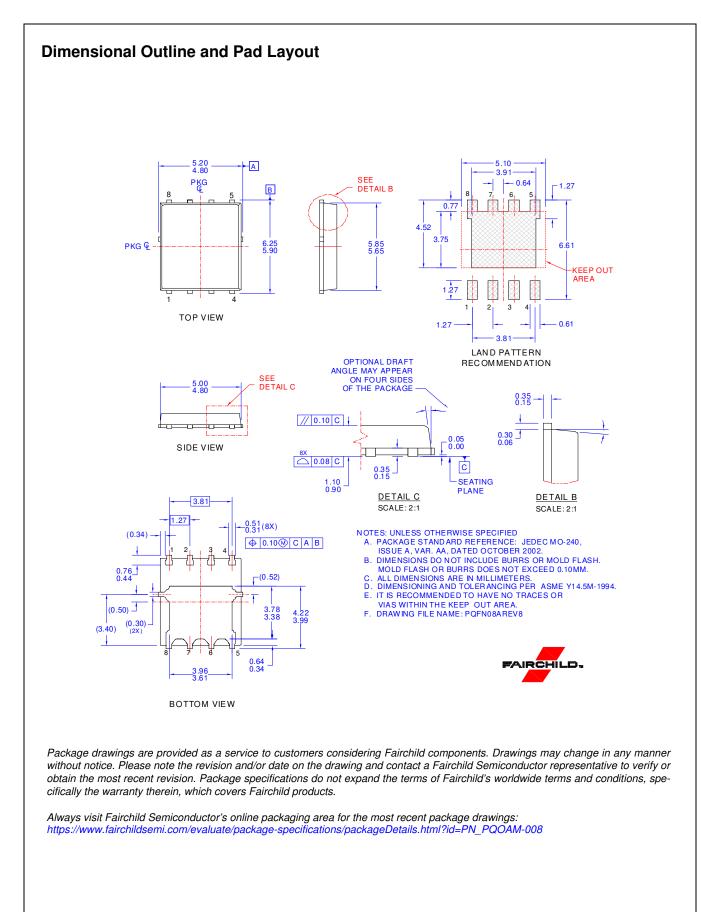


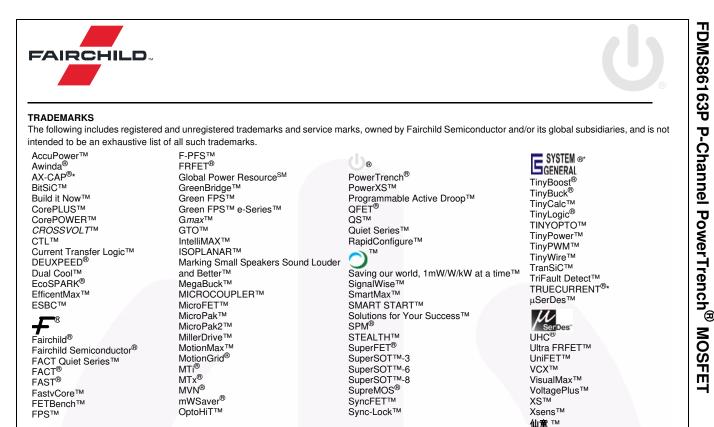




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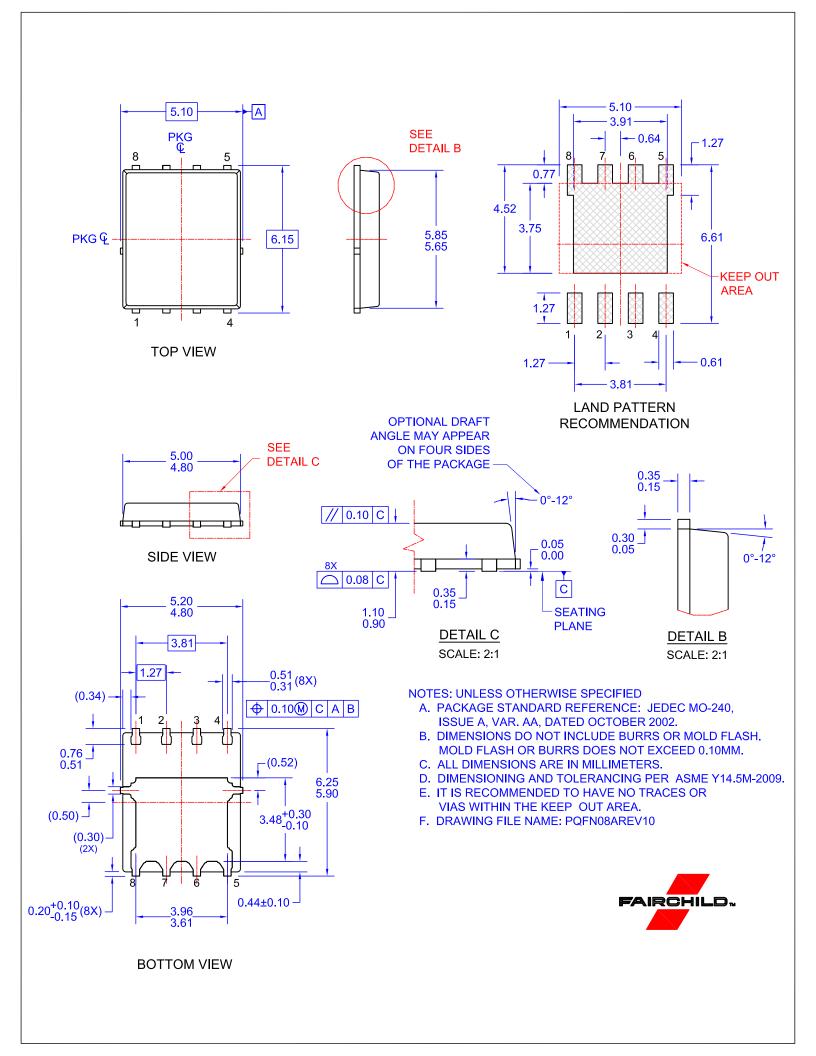
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